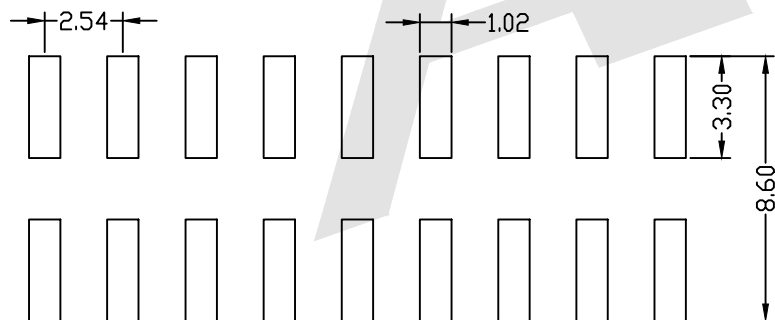
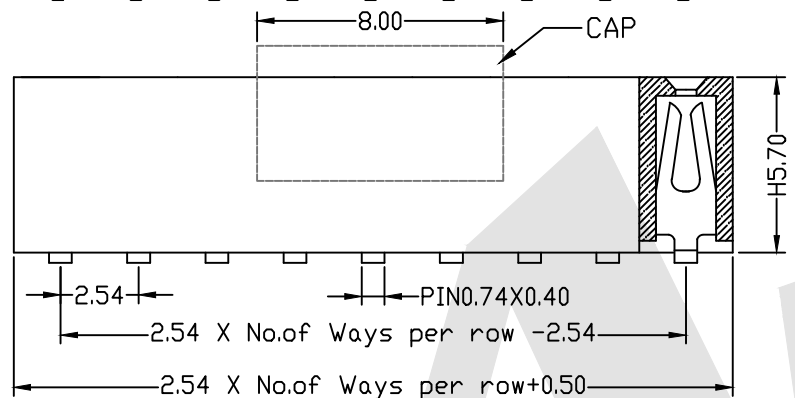
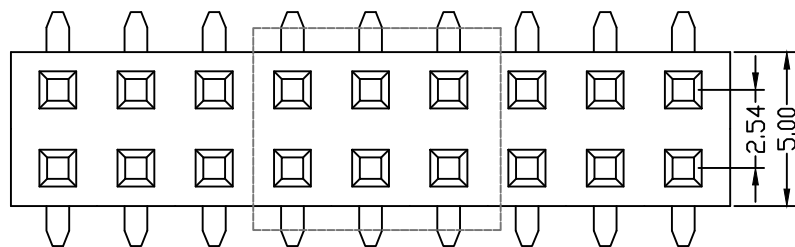
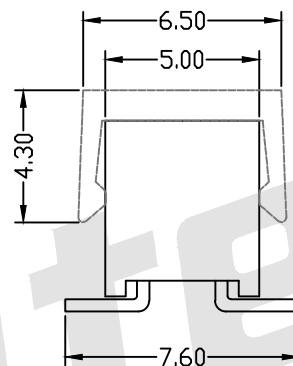


HSF



PCB LAYOUT



SPECIFICATION

Current Rating: 3.0 Amp
Insulation Resistance: 1000M ohms min
Contact Resistance: 20M ohms max
Dielectric Withstanding: AC500V
Operating Temperature: -65 °C to +125 °C
Contact Material: Brass
Insulator Material: PA6T, UL 94V-0 Black

Ordering Code:

FHEM11 - X - X - D - X - X - X
① ② ③ ④ ⑤ ⑥ ⑦

- ① Series No:
② No. of Contacts: 02 To 80
③ Contact Plating:
G0: Gold flash S0: Selective
G1: 3u" Gold S1: Selective 3u"
G2: 5u" Gold S2: Selective 5u"
G3: 10u" Gold S3: Selective 10u"
G4: 15u" Gold S4: Selective 15u"
G5: 30u" Gold S5: Selective 30u"
SN: Tin
④ Connector Type:
D: Dual
⑤ Plastic High:
H: 5.7
Please mark the desired length in the H
- ⑥ Insulator Material:
A: PBT
B: PA6T
C: LCP
D: PA46
E: PA9T
⑦ Packing:
A: Tray
B: Bag
T: Tube
U: Tube+CAP
R: Tape&Reel
W: Tape&Reel+CAP

Unless Otherwise specified tolerance
X. ±0.35 X.XX: ±0.20
X.X: ±0.25 X.XXX: ±0.15

SCALE: As Shown UNIT: mm
DRAW YG ZHONG DATE 01/05/2016
CHECK BobYang DATE 01/05/2016



Antenk® ANTENK ELECTRONICS CO., LTD
Http://www.antenk.com
E-mail: sales@antenk.com

TITLE:
2.54mm Female Header Dual Row SMT Type

DRAWING NO: FHEM11-XXDXXX

PRODUCT NO: FHEM11-XXDXXX

REV

DESCRIPTION

DATE